CPC COOPERATIVE PATENT CLASSIFICATION

CHEMISTRY; METALLURGY С (NOTES omitted)

METALLURGY

- C23 COATING METALLIC MATERIAL; COATING MATERIAL WITH METALLIC **MATERIAL; CHEMICAL SURFACE TREATMENT; DIFFUSION TREATMENT** OF METALLIC MATERIAL; COATING BY VACUUM EVAPORATION, BY SPUTTERING, BY ION IMPLANTATION OR BY CHEMICAL VAPOUR **DEPOSITION, IN GENERAL; INHIBITING CORROSION OF METALLIC** MATERIAL OR INCRUSTATION IN GENERAL (NOTES omitted)
- **C23C COATING METALLIC MATERIAL; COATING MATERIAL WITH METALLIC MATERIAL; SURFACE TREATMENT OF METALLIC MATERIAL BY DIFFUSION** INTO THE SURFACE, BY CHEMICAL CONVERSION OR SUBSTITUTION; COATING BY VACUUM EVAPORATION, BY SPUTTERING, BY ION **IMPLANTATION OR BY CHEMICAL VAPOUR DEPOSITION, IN GENERAL (making** metal-coated products by extrusion B21C 23/22; covering with metal by connecting pre-existing layers to articles, see the relevant places, e.g. <u>B21D 39/00</u>, <u>B23K</u>; metallising of glass <u>C03C</u>; metallising mortars, concrete, artificial stone, ceramics or natural stone C04B 41/00; enamelling of, or applying a vitreous layer to, metals C23D; treating metal surfaces or coating of metals by electrolysis or electrophoresis C25D; single-crystal film growth C30B; by metallising textiles D06M 11/83; decorating textiles by locally metallising D06Q 1/04)

NOTE

In this subclass, an operation is considered as pre-treatment or after-treatment when it is specially adapted for, but quite distinct from, the coating process concerned and constitutes an independent operation. If an operation results in the formation of a permanent sub- or upper layer, it is not considered as pre-treatment or after-treatment and is classified as a multi-coating process.

WARNING

The following IPC groups are not in the CPC scheme. The subject matter for these IPC groups is classified in the following CPC groups: C23C 14/36 - C23C 14/44 <u>C23C 14/34</u> - <u>C23C 14/358</u> covered by

Coating by applying the coating material in the molten state

2/00	Hot-dipping or immersion processes for applying the coating material in the molten state without affecting the shape; Apparatus therefor
2/003	• {Apparatus}
2/0032	• • {specially adapted for batch coating of substrate}
2/00322	• • {Details of mechanisms for immersing or removing substrate from molten liquid bath, e.g. basket or lifting mechanism}
2/0034	• {Details related to elements immersed in bath}
2/00342	• • {Moving elements, e.g. pumps or mixers}
2/00344	• • • {Means for moving substrates, e.g. immersed rollers or immersed bearings}
2/00348	• • {Fixed work supports or guides}
2/0035	• • {Means for continuously moving substrate through, into or out of the bath (<u>C23C 2/00344</u> takes precedence)}

2/00361	 • {characterised by structures including means for immersing or extracting the substrate through confining wall area}
2/00362	• • • {Details related to seals, e.g. magnetic means}
2/0038	• • {characterised by the pre-treatment chambers located immediately upstream of the bath or occurring locally before the dipping process }
2/004	• • • {Snouts}
2/006	• {Pattern or selective deposits}
2/0062	• • {without pre-treatment of the material to be coated, e.g. using masking elements such as casings, shields, fixtures or blocking elements }
2/0064	• {using masking layers}
2/02	• Pretreatment of the material to be coated, e.g. for coating on selected surface areas (<u>C23C 2/30</u> takes precedence)
2/022	• • {by heating}

2/0036 . . {Crucibles}

2/0222	• • • { in a reactive atmosphere, e.g. oxidising or reducing atmosphere (<u>C23C 2/024</u> takes precedence) }	4/00	Coating by spi molten state, e discharge (bui
2/0224	• • {Two or more thermal pretreatments}		<u>B23K 9/04</u>)
2/024	• • {by cleaning or etching}	4/01	. Selective coa
2/026	• {Deposition of sublayers, e.g. adhesion layers		treatment of
	or pre-applied alloying elements or corrosion	4/02	 Pretreatment
	protection}		coating on se
2/04	 characterised by the coating material 	4/04	 characterised
2/06	Zinc or cadmium or alloys based thereon	4/06	• • Metallic m
2/08	• Tin or alloys based thereon	4/067	• • • containi
2/10	. Lead or alloys based thereon		e.g. carb
2/12	Aluminium or alloys based thereon	1/050	arsenic
2/14	• Removing excess of molten coatings; Controlling or regulating the coating thickness	4/073	••• containi is nickel
2/16	• • using fluids under pressure, e.g. air knives	1 (0.0	metal el
2/18	• • Removing excess of molten coatings from elongated material	4/08	••• containit takes pro
2/185	• • • • {Tubes; Wires}	4/10	• • Oxides, bo Mixtures t
2/20	Strips; Plates	4/11	• • • Oxides
2/22	• • by rubbing, e.g. using knives {, e.g. rubbing	4/11 4/12	
	solids}		characterised
2/24	• • using magnetic or electric fields	4/123	Spraying r Detonation
2/26	• After-treatment (<u>C23C 2/14</u> takes precedence)	4/126	
2/261	• • {in a gas atmosphere, e.g. inert or reducing	4/129 4/131	Flame spra Wire arc spra
	atmosphere }	4/131	Whe are spi
2/265	• • {by applying solid particles to the molten	4/134	Spraying i
0/00	coating}	4/137	• • Spraying I
2/28	• Thermal after-treatment, e.g. treatment in oil bath	4/14	•••• Wires; 7
2/285	• • {for remelting the coating}	4/10	• • • • • • • • • • • • • • • • • • •
2/29	• • {Cooling or quenching}	4/18	• {Separatio
2/30	• Fluxes or coverings on molten baths (<u>C23C 2/22</u> takes precedence)		
2/32	 using vibratory energy applied to the bath or substrate (<u>C23C 2/14</u> takes precedence) 	6/00	Coating by cas substrate
2/325	• {Processes or devices for cleaning the bath}	Solid state d	iffusion into meta
2/34	• characterised by the shape of the material to be treated ($C23C 2/14$ takes precedence)	<u>8/00</u>	Solid state diff
2/36	. Elongated material		into metallic n
2/38	Wires; Tubes		<u>C23C 10/00</u>); (
2/385	• • • • {Tubes of specific length}		metallic mater
2/40	Plates; Strips		reactive gas, le material in the
2/405	• • • • {Plates of specific length}		
	· · · · (· · · · · · · · · · · · · · ·		nassivation of
2/50	• {Controlling or regulating the coating processes (C23C 2/14 takes precedence)}	8/02	passivation of Pretreatment (C23C 8/04 t
	 {Controlling or regulating the coating processes (C23C 2/14 takes precedence)} . {Computer-controlled implementation} 		• Pretreatment (C23C 8/04 t
2/50 2/51 2/52	 {Controlling or regulating the coating processes (C23C 2/14 takes precedence)} {Computer-controlled implementation} {with means for measuring or sensing} 	8/02 8/04	• Pretreatment
2/50 2/51	 {Controlling or regulating the coating processes (C23C 2/14 takes precedence)} {Computer-controlled implementation} {with means for measuring or sensing} {Composition of the bath} 		 Pretreatment (<u>C23C 8/04 t</u> Treatment of masks
2/50 2/51 2/52	 {Controlling or regulating the coating processes (C23C 2/14 takes precedence)} {Computer-controlled implementation} {with means for measuring or sensing} {Composition of the bath} {Temperature of the bath} 	8/04	 Pretreatment (<u>C23C 8/04</u> t Treatment of
2/50 2/51 2/52 2/521	 {Controlling or regulating the coating processes (C23C 2/14 takes precedence)} {Computer-controlled implementation} {with means for measuring or sensing} {Composition of the bath} {Temperature of the bath} {Bath level or amount} 	8/04 8/06	 Pretreatment (<u>C23C 8/04</u> t) Treatment of masks using gases (
2/50 2/51 2/52 2/521 2/522	 {Controlling or regulating the coating processes (C23C 2/14 takes precedence)} {Computer-controlled implementation} {with means for measuring or sensing} {Composition of the bath} {Temperature of the bath} {Bath level or amount} {Position of the substrate} 	8/04 8/06 8/08	 Pretreatment (C23C 8/04 t) Treatment of masks using gases (only one e Oxidisir
2/50 2/51 2/52 2/521 2/522 2/523	 {Controlling or regulating the coating processes (C23C 2/14 takes precedence)} {Computer-controlled implementation} {with means for measuring or sensing} {Composition of the bath} {Composition of the bath} {Temperature of the bath} {Bath level or amount} {Position of the substrate} {for reducing vibrations of the substrate} 	8/04 8/06 8/08 8/10	 Pretreatment (<u>C23C 8/04</u> t) Treatment of masks using gases (only one e
2/50 2/51 2/52 2/521 2/522 2/523 2/524	 {Controlling or regulating the coating processes (C23C 2/14 takes precedence)} {Computer-controlled implementation} {with means for measuring or sensing} {Composition of the bath} {Composition of the bath} {Temperature of the bath} {Bath level or amount} {Position of the substrate} {for reducing vibrations of the substrate} {Speed of the substrate} 	8/04 8/06 8/08 8/10 8/12	 Pretreatment (C23C 8/04 t) Treatment of masks using gases (only one e Oxidisir using
2/50 2/51 2/52 2/521 2/522 2/523 2/524 2/5245	 {Controlling or regulating the coating processes (C23C 2/14 takes precedence)} {Computer-controlled implementation} {with means for measuring or sensing} {Composition of the bath} {Composition of the bath} {Temperature of the bath} {Bath level or amount} {Bath level or amount} {Fosition of the substrate} {for reducing vibrations of the substrate} {Speed of the substrate} {for visually inspecting the surface quality of the substrate} 	8/04 8/06 8/08 8/10 8/12 8/14	 Pretreatment (C23C 8/04 t) Treatment of masks using gases (only one e Oxidisin using Oxidisin Oxidisin
2/50 2/51 2/52 2/521 2/522 2/523 2/524 2/5245 2/525	 {Controlling or regulating the coating processes (C23C 2/14 takes precedence)} {Computer-controlled implementation} {with means for measuring or sensing} {Composition of the bath} {Temperature of the bath} {Bath level or amount} {Bath level or amount} {For reducing vibrations of the substrate} {Speed of the substrate} {for visually inspecting the surface quality of the substrate} {of the mixing or stirring the bath} 	8/04 8/06 8/08 8/10 8/12 8/14 8/16	 Pretreatment (C23C 8/04 t) Treatment of masks using gases (only one e oxidisir oxidisir using oxidisir using using using using
2/50 2/51 2/52 2/521 2/522 2/523 2/524 2/5245 2/525 2/526	 {Controlling or regulating the coating processes (C23C 2/14 takes precedence)} {Computer-controlled implementation} {with means for measuring or sensing} {Composition of the bath} {Composition of the bath} {Temperature of the bath} {Bath level or amount} {Position of the substrate} {for reducing vibrations of the substrate} {Speed of the substrate} {for visually inspecting the surface quality of the substrate} {of the mixing or stirring the bath} {using static devices separate from the 	8/04 8/06 8/08 8/10 8/12 8/14 8/16 8/18	 Pretreatment (C23C 8/04 t) Treatment of masks using gases (only one e only one e Oxidisir using using using using oxid
2/50 2/51 2/52 2/521 2/522 2/523 2/524 2/524 2/525 2/526 2/54	 {Controlling or regulating the coating processes (C23C 2/14 takes precedence)} {Computer-controlled implementation} {with means for measuring or sensing} {Composition of the bath} {Composition of the bath} {Temperature of the bath} {Bath level or amount} {Position of the substrate} {for reducing vibrations of the substrate} {Speed of the substrate} {for visually inspecting the surface quality of the substrate} {of the mixing or stirring the bath} {using static devices separate from the substrate, e.g. a fixed plate} 	8/04 8/06 8/08 8/10 8/12 8/14 8/16 8/18 8/20	 Pretreatment (C23C 8/04 t) Treatment of masks using gases (only one e Oxidisir Using Oxidisir Using Oxidisir Oxidisir Oxidisir Oxidisir Carburis
2/50 2/51 2/52 2/521 2/522 2/523 2/524 2/5245 2/525 2/526 2/526	 {Controlling or regulating the coating processes (C23C 2/14 takes precedence)} {Computer-controlled implementation} {with means for measuring or sensing} {Composition of the bath} {Temperature of the bath} {Bath level or amount} {Position of the substrate} {for reducing vibrations of the substrate} {Speed of the substrate} {for visually inspecting the surface quality of the substrate} {of the mixing or stirring the bath} {using static devices separate from the substrate, e.g. a fixed plate} {using moving mixing devices separate from 	8/04 8/06 8/08 8/10 8/12 8/14 8/16 8/18 8/20 8/22	 Pretreatment (C23C 8/04 t) Treatment of masks using gases (only one e Oxidisir Oxidisir Using water Oxidising Carburis of ferminal
2/50 2/51 2/52 2/521 2/522 2/523 2/524 2/524 2/525 2/526 2/54	 {Controlling or regulating the coating processes (C23C 2/14 takes precedence)} {Computer-controlled implementation} {with means for measuring or sensing} {Composition of the bath} {Composition of the bath} {Temperature of the bath} {Bath level or amount} {Position of the substrate} {for reducing vibrations of the substrate} {Speed of the substrate} {for visually inspecting the surface quality of the substrate} {of the mixing or stirring the bath} {using static devices separate from the substrate, e.g. a fixed plate} 	8/04 8/06 8/08 8/10 8/12 8/14 8/16 8/18 8/20 8/22 8/24	 Pretreatment (C23C 8/04 t) Treatment of masks using gases (only one e Oxidisir Oxidisir Using water Oxidisir Carburis Offer Nitridin

4/00	Coating by spraying the coating material in the
-,00	molten state, e.g. by flame, plasma or electric
	discharge (build-up welding <u>B23K</u> , e.g. <u>B23K 5/18</u> ,
	<u>B23K 9/04</u>)
4/01	• Selective coating, e.g. pattern coating, without pre- treatment of the material to be coated
4/02	• Pretreatment of the material to be coated, e.g. for
4/02	coating on selected surface areas
4/04	 characterised by the coating material
4/06	• • Metallic material
4/067	• • containing free particles of non-metal elements, e.g. carbon, silicon, boron, phosphorus or arsenic
4/073	containing MCrAl or MCrAlY alloys, where M is nickel, cobalt or iron, with or without non-metal elements
4/08	• • • containing only metal elements (<u>C23C 4/073</u> takes precedence)
4/10	• Oxides, borides, carbides, nitrides or silicides; Mixtures thereof
4/11	Oxides
4/12	• characterised by the method of spraying
4/123	• • Spraying molten metal
4/126	• Detonation spraying
4/129	• Flame spraying
4/131	• • Wire arc spraying
4/134	Plasma spraying
4/137	• • Spraying in vacuum or in an inert atmosphere
4/14	• • for coating elongate material
4/16	Wires; Tubes
4/18	. After-treatment
4/185	• • {Separation of the coating from the substrate}
6/00	Coating by casting molten material on the substrate
d state di	ffusion into metallic material surfaces
8/00	Solid state diffusion of only non-metal elements
	into metallic material surfaces (diffusion of silicon
	<u>C23C 10/00</u>); Chemical surface treatment of
	metallic material by reaction of the surface with a reactive gas, leaving reaction products of surface
	material in the coating, e.g. conversion coatings,
	passivation of metals (<u>C23C 14/00</u> takes precedence)
8/02	• Pretreatment of the material to be coated
0/01	(C23C 8/04 takes precedence)
8/04	• Treatment of selected surface areas, e.g. using masks
8/06	• using gases (<u>C23C 8/36</u> takes precedence)
8/08	 only one element being applied
8/10	• • Oxidising
8/12	• • • using elemental oxygen or ozone
8/14	••••••••••••••••••••••••••••••••••••••
8/16	• • • using oxygen-containing compounds, e.g. water, carbon dioxide
8/18	• • • • • Oxidising of ferrous surfaces
8/20	Carburising
8/22	• • • • • • • • • • • • • • • • • • •
8/24	· · · · · · · · · · · · · · · · · · ·
	Nitriding
8/26	Nitriding of ferrous surfaces
8/26 8/28	of ferrous surfaces
	5

8/34	• more than one element being applied in more than one step
8/36	• • using ionised gases, e.g. ionitriding
8/38	• • • Treatment of ferrous surfaces
8/40	• using liquids, e.g. salt baths, liquid suspensions
8/42	 only one element being applied
8/44	Carburising
8/46	• • • • • • • • • • • • • • • • • • •
8/48	Nitriding
8/50	• • • • • • • • • • • • • • • • • • •
8/52	 more than one element being applied in one step
8/52 8/54	Carbo-nitriding
8/34 8/56	of ferrous surfaces
8/58	• more than one element being applied in more than one step
8/60	 using solids, e.g. powders, pastes (using liquid suspensions of solids <u>C23C 8/40</u>)
8/62	• • only one element being applied
8/64	Carburising
8/66	of ferrous surfaces
8/68	Boronising
8/70	of ferrous surfaces
8/72	more than one element being applied in one step
8/74	Carbo-nitriding
8/76	of ferrous surfaces
8/78	• • more than one element being applied in more than
	one step
8/80	. After-treatment
10/00	Solid state diffusion of only metal elements or
	silicon into metallic material surfaces
10/02	• Pretreatment of the material to be coated (C23C 10/04 takes precedence)
10/02 10/04	• Pretreatment of the material to be coated
	• Pretreatment of the material to be coated (<u>C23C 10/04</u> takes precedence)
	 Pretreatment of the material to be coated (C23C 10/04 takes precedence) Diffusion into selected surface areas, e.g. using
10/04	 Pretreatment of the material to be coated (C23C 10/04 takes precedence) Diffusion into selected surface areas, e.g. using masks
10/04 10/06	 Pretreatment of the material to be coated (C23C 10/04 takes precedence) Diffusion into selected surface areas, e.g. using masks using gases
10/04 10/06 10/08	 Pretreatment of the material to be coated (C23C 10/04 takes precedence) Diffusion into selected surface areas, e.g. using masks using gases only one element being diffused
10/04 10/06 10/08 10/10	 Pretreatment of the material to be coated (C23C 10/04 takes precedence) Diffusion into selected surface areas, e.g. using masks using gases only one element being diffused Chromising
10/04 10/06 10/08 10/10 10/12	 Pretreatment of the material to be coated (C23C 10/04 takes precedence) Diffusion into selected surface areas, e.g. using masks using gases only one element being diffused Chromising of ferrous surfaces
10/04 10/06 10/08 10/10 10/12 10/14	 Pretreatment of the material to be coated (C23C 10/04 takes precedence) Diffusion into selected surface areas, e.g. using masks using gases only one element being diffused Chromising of ferrous surfaces more than one element being diffused in one step more than one element being diffused in more than one step
10/04 10/06 10/08 10/10 10/12 10/14 10/16	 Pretreatment of the material to be coated (C23C 10/04 takes precedence) Diffusion into selected surface areas, e.g. using masks using gases only one element being diffused Chromising of ferrous surfaces more than one element being diffused in one step more than one element being diffused in more
10/04 10/06 10/08 10/10 10/12 10/14 10/16 10/18	 Pretreatment of the material to be coated (C23C 10/04 takes precedence) Diffusion into selected surface areas, e.g. using masks using gases only one element being diffused Chromising of ferrous surfaces more than one element being diffused in one step more than one element being diffused in more than one step using liquids, e.g. salt baths, liquid suspensions
10/04 10/06 10/08 10/10 10/12 10/14 10/16 10/18 10/20	 Pretreatment of the material to be coated (C23C 10/04 takes precedence) Diffusion into selected surface areas, e.g. using masks using gases only one element being diffused Chromising of ferrous surfaces more than one element being diffused in one step more than one element being diffused in more than one step using liquids, e.g. salt baths, liquid suspensions only one element being diffused
10/04 10/06 10/08 10/10 10/12 10/14 10/16 10/18 10/20	 Pretreatment of the material to be coated (C23C 10/04 takes precedence) Diffusion into selected surface areas, e.g. using masks using gases only one element being diffused Chromising of ferrous surfaces more than one element being diffused in one step more than one element being diffused in more than one step using liquids, e.g. salt baths, liquid suspensions only one element being diffused Metal melt containing the element to be diffused
10/04 10/06 10/08 10/10 10/12 10/14 10/16 10/18 10/20 10/22	 Pretreatment of the material to be coated (C23C 10/04 takes precedence) Diffusion into selected surface areas, e.g. using masks using gases only one element being diffused Chromising of ferrous surfaces more than one element being diffused in one step more than one element being diffused in more than one step using liquids, e.g. salt baths, liquid suspensions only one element being diffused Metal melt containing the element to be diffused Salt bath containing the element to be diffused
10/04 10/06 10/08 10/10 10/12 10/14 10/16 10/18 10/20 10/22 10/24	 Pretreatment of the material to be coated (C23C 10/04 takes precedence) Diffusion into selected surface areas, e.g. using masks using gases only one element being diffused Chromising of ferrous surfaces more than one element being diffused in one step more than one element being diffused in more than one step using liquids, e.g. salt baths, liquid suspensions only one element being diffused Metal melt containing the element to be diffused Salt bath containing the element to be diffused more than one element being diffused
10/04 10/06 10/08 10/10 10/12 10/14 10/16 10/18 10/20 10/22 10/24 10/24	 Pretreatment of the material to be coated (C23C 10/04 takes precedence) Diffusion into selected surface areas, e.g. using masks using gases only one element being diffused Chromising of ferrous surfaces more than one element being diffused in one step more than one element being diffused in more than one step using liquids, e.g. salt baths, liquid suspensions only one element being diffused Salt bath containing the element to be diffused Salt bath containing the element to be diffused more than one element being diffused
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10/04 10/06 10/08 10/10 10/12 10/14 10/16 10/18 10/20 10/22 10/24 10/26 10/28 10/30 10/32	 Pretreatment of the material to be coated (C23C 10/04 takes precedence) Diffusion into selected surface areas, e.g. using masks using gases only one element being diffused Chromising of ferrous surfaces more than one element being diffused in one step more than one element being diffused in more than one step using liquids, e.g. salt baths, liquid suspensions only one element being diffused Metal melt containing the element to be diffused salt bath containing the element to be diffused more than one element being diffused using solids, e.g. powders, pastes using a layer of powder or paste on the surface (using liquid suspensions of solids C23C 10/18) Chromising
10/04 10/06 10/08 10/10 10/12 10/14 10/16 10/18 10/20 10/22 10/24 10/26 10/28 10/30 10/32 10/34	 Pretreatment of the material to be coated (C23C 10/04 takes precedence) Diffusion into selected surface areas, e.g. using masks using gases only one element being diffused Chromising of ferrous surfaces more than one element being diffused in one step more than one element being diffused in more than one step using liquids, e.g. salt baths, liquid suspensions only one element being diffused Metal melt containing the element to be diffused salt bath containing the element to be diffused more than one element being diffused conly one element being diffused only one element being diffused Chromising the element to be diffused using a layer of powder or paste on the surface (using liquid suspensions of solids C23C 10/18) Chromising Embedding in a powder mixture, i.e. pack cementation
10/04 10/06 10/08 10/10 10/12 10/14 10/16 10/18 10/20 10/22 10/24 10/26 10/28 10/30 10/32 10/34	 Pretreatment of the material to be coated (C23C 10/04 takes precedence) Diffusion into selected surface areas, e.g. using masks using gases only one element being diffused Chromising of ferrous surfaces more than one element being diffused in one step more than one element being diffused in more than one step using liquids, e.g. salt baths, liquid suspensions only one element being diffused Metal melt containing the element to be diffused Salt bath containing the element to be diffused more than one element being diffused Chromising Chromising Embedding in a powder mixture, i.e. pack cementation only one element being diffused
10/04 10/06 10/08 10/10 10/12 10/14 10/16 10/18 10/20 10/22 10/24 10/26 10/28 10/30 10/32 10/34 10/36 10/38	 Pretreatment of the material to be coated (C23C 10/04 takes precedence) Diffusion into selected surface areas, e.g. using masks using gases only one element being diffused Chromising of ferrous surfaces more than one element being diffused in one step more than one element being diffused in more than one step using liquids, e.g. salt baths, liquid suspensions only one element being diffused Metal melt containing the element to be diffused Salt bath containing the element to be diffused more than one element being diffused Susing solids, e.g. powders, pastes using a layer of powder or paste on the surface (using liquid suspensions of solids C23C 10/18) Chromising Embedding in a powder mixture, i.e. pack cementation only one element being diffused
10/04 10/06 10/08 10/10 10/12 10/14 10/16 10/18 10/20 10/22 10/24 10/26 10/28 10/30 10/32 10/34	 Pretreatment of the material to be coated (C23C 10/04 takes precedence) Diffusion into selected surface areas, e.g. using masks using gases only one element being diffused Chromising of ferrous surfaces more than one element being diffused in one step more than one element being diffused in more than one step using liquids, e.g. salt baths, liquid suspensions only one element being diffused Metal melt containing the element to be diffused Salt bath containing the element to be diffused more than one element being diffused Salt bath containing the element to be diffused using solids, e.g. powders, pastes using liquid suspensions of solids C23C 10/18) Chromising Embedding in a powder mixture, i.e. pack cementation only one element being diffused to nly one element being diffused
10/04 10/06 10/08 10/10 10/12 10/14 10/16 10/18 10/20 10/22 10/24 10/26 10/28 10/30 10/32 10/34 10/36 10/38	 Pretreatment of the material to be coated (C23C 10/04 takes precedence) Diffusion into selected surface areas, e.g. using masks using gases only one element being diffused Chromising of ferrous surfaces more than one element being diffused in one step more than one element being diffused in more than one step using liquids, e.g. salt baths, liquid suspensions only one element being diffused Metal melt containing the element to be diffused Salt bath containing the element to be diffused more than one element being diffused using solids, e.g. powders, pastes using liquid suspensions of solids C23C 10/18) Chromising Embedding in a powder mixture, i.e. pack cementation only one element being diffused only one element being diffused
10/04 10/06 10/08 10/10 10/12 10/14 10/16 10/18 10/20 10/22 10/24 10/26 10/28 10/30 10/32 10/34 10/36 10/38 10/40 10/42	 Pretreatment of the material to be coated (C23C 10/04 takes precedence) Diffusion into selected surface areas, e.g. using masks using gases only one element being diffused Chromising of ferrous surfaces more than one element being diffused in one step more than one element being diffused in more than one step using liquids, e.g. salt baths, liquid suspensions only one element being diffused Metal melt containing the element to be diffused salt bath containing the element to be diffused more than one element being diffused using solids, e.g. powders, pastes using a layer of powder or paste on the surface (using liquid suspensions of solids C23C 10/18) Chromising Embedding in a powder mixture, i.e. pack cementation only one element being diffused in the presence of volatile transport additives, e.g. halogenated substances
10/04 10/06 10/08 10/10 10/12 10/14 10/16 10/18 10/20 10/22 10/24 10/26 10/28 10/30 10/32 10/34 10/36 10/38 10/40	 Pretreatment of the material to be coated (C23C 10/04 takes precedence) Diffusion into selected surface areas, e.g. using masks using gases only one element being diffused Chromising of ferrous surfaces more than one element being diffused in one step more than one element being diffused in more than one step using liquids, e.g. salt baths, liquid suspensions only one element being diffused Metal melt containing the element to be diffused Salt bath containing the element to be diffused more than one element being diffused using solids, e.g. powders, pastes using a layer of powder or paste on the surface (using liquid suspensions of solids C23C 10/18) Chromising Embedding in a powder mixture, i.e. pack cementation only one element being diffused there is a powder surface site of the provident of the surface for the provident of the surface site of the provident of the surface site of the surface site of the provident of the provident of the surface site of the provident of the surface site of the provident of the provi
10/04 10/06 10/08 10/10 10/12 10/14 10/16 10/18 10/20 10/22 10/24 10/26 10/28 10/30 10/32 10/34 10/36 10/38 10/40 10/42	 Pretreatment of the material to be coated (C23C 10/04 takes precedence) Diffusion into selected surface areas, e.g. using masks using gases only one element being diffused Chromising of ferrous surfaces more than one element being diffused in one step more than one element being diffused in more than one step using liquids, e.g. salt baths, liquid suspensions only one element being diffused Metal melt containing the element to be diffused salt bath containing the element to be diffused more than one element being diffused using solids, e.g. powders, pastes using a layer of powder or paste on the surface (using liquid suspensions of solids C23C 10/18) Chromising Embedding in a powder mixture, i.e. pack cementation only one element being diffused in the presence of volatile transport additives, e.g. halogenated substances

14/00	element other than silicon and at least one metal element or silicon into metallic material surfaces
12/00	Solid state diffusion of at least one non-metal
10/60	• After-treatment
	than one step
10/58	more than one element being diffused in more
10/56	•••• and at least aluminium
10/54	Diffusion of at least chromium
	step
10/52	more than one element being diffused in one

12/02 . Diffusion in one step

<u>Coating by vacuum evaporation, by sputtering or by ion</u> <u>implantation</u>

14/00	Coating by vacuum evaporation, by sputtering or by ion implantation of the coating forming
14/0005	material
14/0005	• {Separation of the coating from the substrate}
14/001	• {Coating on a liquid substrate}
14/0015	• {characterized by the colour of the layer}
14/0021	• {Reactive sputtering or evaporation}
14/0026	• • {Activation or excitation of reactive gases outside the coating chamber}
14/0031	• • • {Bombardment of substrates by reactive ion beams}
14/0036	• • {Reactive sputtering}
14/0042	• • • {Controlling partial pressure or flow rate
	of reactive or inert gases with feedback of measurements}
14/0047	• • • {Activation or excitation of reactive gases outside the coating chamber}
14/0052	• • • {Bombardment of substrates by reactive ion beams}
14/0057	• • { using reactive gases other than O ₂ , H ₂ O, N ₂ , NH ₃ or CH ₄ }
14/0063	• • {characterised by means for introducing or removing gases}
14/0068	 {characterised by means for confinement of gases or sputtered material, e.g. screens, baffles}
14/0073	• • {by exposing the substrates to reactive gases intermittently}
14/0078	•••• {by moving the substrates between spatially separate sputtering and reaction stations}
14/0084	• • • {Producing gradient compositions}
14/0089	• • • {in metallic mode}
14/0094	• • • {in transition mode}
14/02	• Pretreatment of the material to be coated (C23C 14/04 takes precedence)
14/021	• • {Cleaning or etching treatments}
14/022	• • {by means of bombardment with energetic particles or radiation}
14/024	• {Deposition of sublayers, e.g. to promote adhesion of the coating (<u>C23C 14/027</u> takes precedence)}
14/025	{Metallic sublayers}
14/027	• • {Graded interfaces}
14/028	• {Physical treatment to alter the texture of the substrate surface, e.g. grinding, polishing}
14/04	• Coating on selected surface areas, e.g. using masks
14/042	• • {using masks}

10/50

. . . . of ferrous surfaces

14/044	• • • {using masks to redistribute rather than totally prevent coating, e.g. producing thickness
	gradient}
14/046	• • {Coating cavities or hollow spaces, e.g. interior of tubes; Infiltration of porous substrates}
14/048	• • {using irradiation by energy or particles}
14/06	 characterised by the coating material
	$(\{\underline{C23C \ 14/0021}\}, \underline{C23C \ 14/04} \text{ take precedence})$
14/0605	••• {Carbon}
14/0611	• • {Diamond}
14/0617	• {AIII BV compounds, where A is Al, Ga, In or Tl and B is N, P, As, Sb or Bi}
14/0623	 . {Sulfides, selenides or tellurides}
14/0623	 {Surfaces, selendes of tenandes} {of zinc, cadmium or mercury}
14/0635	 . {Carbides}
14/0641	 {Nitrides (<u>C23C 14/0617</u> takes precedence)}
14/0647	• • {Boron nitride}
14/0652	• • {Silicon nitride}
14/0658	• • {Carbon nitride}
14/0664	• • {Carbonitrides}
14/067	• • {Borides}
14/0676	• • {Oxynitrides}
14/0682	• {Silicides}
14/0688	• • {Cermets, e.g. mixtures of metal and one or more
	of carbides, nitrides, oxides or borides}
14/0694	• • {Halides}
14/08	• • Oxides (<u>C23C 14/10</u> takes precedence)
14/081	• • • {of aluminium, magnesium or beryllium}
14/082	• • • {of alkaline earth metals}
14/083	• • • {of refractory metals or yttrium}
14/085	• • • {of iron group metals}
14/086	• • • {of zinc, germanium, cadmium, indium, tin,
14/087	thallium or bismuth}• { of copper or solid solutions thereof }
14/087	• • {of the type ABO ₃ with A representing alkali,
14/000	alkaline earth metal or Pb and B representing a
14/10	refractory or rare earth metal}
14/10	Glass or silica
14/12	Organic material Matellia material haran ar siliaan
14/14 14/16	 Metallic material, boron or silicon on metallic substrates or on substrates of boron
14/10	or silicon
14/165	• • • {by cathodic sputtering}
14/18	• • • on other inorganic substrates
14/185	• • • {by cathodic sputtering}
14/20	• • • on organic substrates
14/205	• • • {by cathodic sputtering}
14/22	• characterised by the process of coating
14/221	• • {Ion beam deposition (<u>C23C 14/46</u> , <u>C23C 14/48</u>
	take precedence)}
14/223	• • {specially adapted for coating particles}
14/225	• • {Oblique incidence of vaporised material on
14/226	substrate }
14/226	• • • {in order to form films with columnar structure}
14/228	• {Gas flow assisted PVD deposition}
14/24	Vacuum evaporation
14/243	• • {Crucibles for source material (<u>C23C 14/28</u> ,
	C23C 14/30 take precedence)}
14/246	• • • {Replenishment of source material}
14/26	by resistance or inductive heating of the source
14/28	• • • by wave energy or particle radiation
	(<u>C23C 14/32</u> - <u>C23C 14/48</u> take precedence)

C25C

14/30	• • • by electron bombardment
14/32	• • • by explosion; by evaporation and subsequent
	ionisation of the vapours {, e.g. ion-
	plating}(<u>C23C 14/34</u> - <u>C23C 14/48</u> take
	precedence)
14/325	• • • • {Electric arc evaporation}
14/34	• • Sputtering
14/3407	• • • {Cathode assembly for sputtering apparatus,
	e.g. Target}
14/3414	{Metallurgical or chemical aspects of target
	preparation, e.g. casting, powder metallurgy
14/3421	• • • {using heated targets}
14/3428	•••• {using liquid targets}
14/3435	• • • {Applying energy to the substrate during
	sputtering }
14/3442	• • • {using an ion beam}
14/345	• • • {using substrate bias}
14/3457	• • • {using other particles than noble gas ions
	(<u>C23C 14/0036</u> , <u>C23C 14/46</u> take precedence)
14/3464	• • • {using more than one target ($\underline{C23C \ 14/56}$ takes
	precedence)}
14/3471	• • • {Introduction of auxiliary energy into the
	plasma}
14/3478	• • • {using electrons, e.g. triode sputtering}
14/3485	• • { using pulsed power to the target }
14/3492	• • {Variation of parameters during sputtering}
14/35	• • • by application of a magnetic field, e.g.
	magnetron sputtering {(C23C 14/3457 takes
	precedence)}
14/351	• • • { using a magnetic field in close vicinity to
	the substrate }
14/352	• • • • {using more than one target ($\underline{C23C \ 14/56}$
	takes precedence)}
14/354	• • • • {Introduction of auxiliary energy into the
	plasma}
14/355	• • • • {using electrons, e.g. triode sputtering}
14/357	• • • • • {Microwaves, e.g. electron cyclotron
	resonance enhanced sputtering}
14/358	{Inductive energy}
14/46	• • • by ion beam produced by an external ion
	source
14/48	• • Ion implantation
14/50	Substrate holders
14/505	• • • {for rotation of the substrates}
14/52	• • Means for observation of the coating process
14/54	• • Controlling or regulating the coating process
14/541	• • • {Heating or cooling of the substrates}
14/542	$\hfill \hfill $
	rate }
14/543	• • • { using measurement on the vapor source }
14/544	• • • { using measurement in the gas phase }
14/545	• • • { using measurement on deposited material }
14/546	•••• {using crystal oscillators}
14/547	• • • • {using optical methods}
14/548	• • • {Controlling the composition}
14/56	• Apparatus specially adapted for continuous
	coating; Arrangements for maintaining the
	vacuum, e.g. vacuum locks
14/562	• • • {for coating elongated substrates}
14/564	• • • {Means for minimising impurities in the
	coating chamber such as dust, moisture,
	residual gases}
14/566	• • • • {using a load-lock chamber}

14/568	• • • {Transferring the substrates through a series
	of coating stations (C23C 14/562 takes
	precedence)}
14/58	. After-treatment
14/5806	• • {Thermal treatment}
14/5813	• • • {using lasers}
14/582	• • • {using electron bombardment}
14/5826	• • {Treatment with charged particles (C23C 14/582
	takes precedence)}
14/5833	• • • {Ion beam bombardment}
14/584	• • {Non-reactive treatment}
14/5846	• • {Reactive treatment}
14/5853	• • • {Oxidation}
14/586	• • • {Nitriding}
14/5866	• • • {Treatment with sulfur, selenium or tellurium}
14/5873	• • {Removal of material}
14/588	• • • {by mechanical treatment}
14/5886	• • {Mechanical treatment (involving removal of
	material <u>C23C 14/588</u>)}
14/5893	• • {Mixing of deposited material}

Chemical deposition or plating by decomposition; Contact plating

16/00 Chemical coating by decomposition of gaseous compounds, without leaving reaction products of surface material in the coating, i.e. chemical vapour deposition [CVD] processes (reactive sputtering or vacuum evaporation C23C 14/00) 16/003 • {Coating on a liquid substrate} 16/006 • {characterized by the colour of the layer} 16/01 • on temporary substrates, e.g. substrates subsequently removed by etching 16/02 . Pretreatment of the material to be coated (C23C 16/04 takes precedence) 16/0209 • {by heating} 16/0218 • • $\{$ in a reactive atmosphere (<u>C23C 16/0227</u> takes precedence)} 16/0227 • {by cleaning or etching} 16/0236 • • {by etching with a reactive gas} 16/0245 • • {by etching with a plasma} 16/0254 • Physical treatment to alter the texture of the surface, e.g. scratching or polishing} 16/0263 • • {Irradiation with laser or particle beam} 16/0272 . . {Deposition of sub-layers, e.g. to promote the adhesion of the main coating} 16/0281 . . . {of metallic sub-layers (C23C 16/029 takes precedence)} 16/029 • • • {Graded interfaces} 16/04 . Coating on selected surface areas, e.g. using masks 16/042 • {using masks} 16/045 . . {Coating cavities or hollow spaces, e.g. interior of tubes; Infiltration of porous substrates} 16/047 • {using irradiation by energy or particles} 16/06 . characterised by the deposition of metallic material 16/08 . . from metal halides 16/10 . . . Deposition of chromium only 16/12 . . . Deposition of aluminium only 16/14 . . . Deposition of only one other metal element 16/16 . . from metal carbonyl compounds 16/18 . . from metallo-organic compounds 16/20 . . . Deposition of aluminium only 16/22 . characterised by the deposition of inorganic

material, other than metallic material

16/24	• • Deposition of silicon only
16/26	. Deposition of carbon only
16/27	Diamond only
16/271	• • • {using hot filaments}
16/272	• • • {using DC, AC or RF discharges}
16/274	• • • {using microwave discharges}
16/275	• • • {using combustion torches}
16/276	• • • {using plasma jets}
16/277	• • • {using other elements in the gas phase besides carbon and hydrogen; using other elements besides carbon, hydrogen and
	oxygen in case of use of combustion torches; using other elements besides carbon, hydrogen and inert gas in case of use of plasma jets}
16/278	• • • {doping or introduction of a secondary phase in the diamond}
16/279	•••• {control of diamond crystallography}
16/28	Deposition of only one other non-metal element
16/30	• Deposition of compounds, mixtures or solid solutions, e.g. borides, carbides, nitrides
16/301	• • • {AIII BV compounds, where A is Al, Ga, In or Tl and B is N, P, As, Sb or Bi}
16/303	• • • • {Nitrides}
16/305	• • {Sulfides, selenides, or tellurides}
16/306	• • • {AII BVI compounds, where A is Zn, Cd or Hg and B is S, Se or Te}
16/308	• • • {Oxynitrides}
16/32	Carbides
16/325	{Silicon carbide}
16/34	• • Nitrides {($\underline{C23C 16/303}$ takes precedence)}
16/342	{Boron nitride}
16/345	{Silicon nitride}
16/347	• • • • {Carbon nitride}
16/36	Carbonitrides
16/38	Borides
16/40	Oxides
16/401	• • • {containing silicon}
16/402	• • • • {Silicon dioxide}
16/403	• • • {of aluminium, magnesium or beryllium}
16/404	• • • • {of alkaline earth metals}
16/405	• • • • {of refractory metals or yttrium}
16/406 16/407	 {of iron group metals} {of zinc, germanium, cadmium, indium, tin,
	thallium or bismuth}
16/408	• • • {of copper or solid solutions thereof}
16/409	 {of the type ABO₃ with A representing alkali, alkaline earth metal or lead and B representing a refractory metal, nickel, scandium or a lanthanide}
16/42	Silicides
16/44	• characterised by the method of coating ($C23C 16/04$
	takes precedence)
16/4401	• • {Means for minimising impurities, e.g. dust, moisture or residual gas, in the reaction chamber}
16/4402	• • • {Reduction of impurities in the source gas}
16/4404	• • • {Coatings or surface treatment on the inside of
16/4405	the reaction chamber or on parts thereof}. (Cleaning of reactor or parts inside the reactor hyperbolic second)
16/4407	by using reactive gases }• {Cleaning of reactor or reactor parts by using wet or mechanical methods }

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16/4408	• • • {by purging residual gases from the reaction
	chamber or gas lines}
16/4409	• • {characterised by sealing means}
16/4411	• {Cooling of the reaction chamber walls
16/4410	$(\underline{\text{C23C 16/45572}} \text{ takes precedence}) \}$
16/4412	• {Details relating to the exhausts, e.g. pumps, filters, scrubbers, particle traps}
16/4414	
16/4414	 . {Electrochemical vapour deposition [EVD]} . {Acoustic wave CVD}
16/4417	 . {Methods specially adapted for coating powder}
16/4417	Methods specially adapted for coalling powder? Methods for making free-standing articles
10/4410	$(\underline{C23C \ 16/01} \text{ takes precedence})\}$
16/442	• • using fluidised bed process
16/448	• • characterised by the method used for generating
	reactive gas streams, e.g. by evaporation or
	sublimation of precursor materials
16/4481	• • • {by evaporation using carrier gas in contact
	with the source material (C23C 16/4486 takes
	precedence)}
16/4482	• • • • {by bubbling of carrier gas through liquid
1.5/1.100	source material }
16/4483	• • • {using a porous body}
16/4485	• • {by evaporation without using carrier
	gas in contact with the source material (C23C 16/4486 takes precedence)}
16/4486	• • {by producing an aerosol and subsequent
10/4400	evaporation of the droplets or particles}
16/4487	• • {by using a condenser}
16/4488	• • • {by <u>in situ</u> generation of reactive gas by
	chemical or electrochemical reaction}
16/452	• • • by activating reactive gas streams before
	{their} introduction into the reaction chamber,
	e.g. by {ionisation} or addition of reactive
	species
16/453	• • passing the reaction gases through burners
	or torches, e.g. atmospheric pressure CVD
	(<u>C23C 16/513</u> takes precedence; for flame or plasma spraying of coating material in the molten
	state <u>C23C 4/00</u>)
16/455	• • characterised by the method used for introducing
10, 100	gases into reaction chamber or for modifying gas
	flows in reaction chamber
16/45502	• • • {Flow conditions in reaction chamber}
16/45504	• • • {Laminar flow}
16/45506	•••• {Turbulent flow}
16/45508	• • • • {Radial flow}
16/4551	{Jet streams}
16/45512	• • • {Premixing before introduction in the reaction
	chamber}
16/45514	
16/45517	• • • {Confinement of gases to vicinity of substrate}
16/45519	{Inert gas curtains}
16/45521	• • • { the gas, other than thermal contact gas,
	being introduced the rear of the substrate to flow around its periphery}
16/45523	• • • {Pulsed gas flow or change of composition
10/73323	over time}
16/45525	• • • {Atomic layer deposition [ALD]}
16/45527	 {characterized by the ALD cycle, e.g.
	different flows or temperatures during
	half-reactions, unusual pulsing sequence,
	use of precursor mixtures or auxiliary
	reactants or activations}

16/45529	••••• (specially adapted for making a
	layer stack of alternating different
	compositions or gradient compositions}
16/45531	••••• {specially adapted for making ternary or
	higher compositions}
16/45534	• • • • • {Use of auxiliary reactants other
	than used for contributing to the
	composition of the main film, e.g.
	catalysts, activators or scavengers}
16/45536	••••• {Use of plasma, radiation or
16/45520	electromagnetic fields}
16/45538	· · · · · · {Plasma being used continuously
16/4554	during the ALD cycle }
16/4554	{Plasma being used non-continuously in between ALD reactions
	(<u>C23C 16/56</u> takes precedence)}
16/45542	• • • • • • {Plasma being used non-continuously
10/45542	during the ALD reactions}
16/45544	• • • • • {characterized by the apparatus}
16/45546	••••••••••••••••••••••••••••••••••••••
10/45540	in the ALD reactor}
16/45548	••••• {having arrangements for gas injection
10, 100 10	at different locations of the reactor for
	each ALD half-reaction}
16/45551	••••• {for relative movement of the
	substrate and the gas injectors or half-
	reaction reactor compartments}
16/45553	• • • • {characterized by the use of precursors
	specially adapted for ALD}
16/45555	• • • • {applied in non-semiconductor
	technology}
16/45557	• • • {Pulsed pressure or control pressure}
16/45559	• • • {Diffusion of reactive gas to substrate}
16/45561	• • • {Gas plumbing upstream of the reaction
1	chamber }
16/45563	• • • {Gas nozzles}
16/45565	{Shower nozzles}
16/45568	· · · · {Porous nozzles}
16/4557	• • • • {Heated nozzles}
16/45572	{Cooled nozzles}
16/45574	
16/45576	• • • {Coaxial inlets for each gas}
16/45578	{Elongated nozzles, tubes with holes}
16/4558	• • • • {Perforated rings}
16/45582	• • • {Expansion of gas before it reaches the substrate}
16/45585	• • {Compression of gas before it reaches the
10/45585	substrate}
16/45587	• • {Mechanical means for changing the gas flow}
16/45589	
16/45591	
16/45593	
16/45595	• • • (Atmospheric CVD gas inlets with no enclosed
10/700/0	reaction chamber}
16/45597	• • {Reactive back side gas}
16/458	 characterised by the method used for supporting
	substrates in the reaction chamber
16/4581	• • { characterised by material of construction or
	surface finish of the means for supporting the
	substrate}
16/4582	• • • {Rigid and flat substrates, e.g. plates or discs
	(C23C 16/4581 takes precedence)}
16/4583	• • • { the substrate being supported substantially
	horizontally}

Chemical deposition or plating by decomposition; Contact plating

16/4584	••••• {the substrate being rotated}
16/4585	{Devices at or outside the perimeter of
	the substrate support, e.g. clamping rings,
16/1596	shrouds}
16/4586	• • • • {Elements in the interior of the support, e.g. electrodes, heating or cooling devices}
16/4587	• • • • {the substrate being supported substantially
	vertically}
16/4588	••••• {the substrate being rotated}
16/46	characterised by the method used for heating
	the substrate (<u>C23C 16/48</u> , <u>C23C 16/50</u> take
	precedence)
16/463	• • • {Cooling of the substrate}
16/466	• • • {using thermal contact gas}
16/48	• by irradiation, e.g. photolysis, radiolysis, particle radiation
16/481	• • {by radiant heating of the substrate}
16/482	• • {using incoherent light, UV to IR, e.g. lamps}
16/483	• • {using coherent light, UV to IR, e.g. lasers}
16/484	• • • {using X-ray radiation}
16/485	• • • {using synchrotron radiation}
16/486	• • • {using ion beam radiation}
16/487	• • • {using electron radiation}
16/488	{Protection of windows for introduction of
	radiation into the coating chamber}
16/50	• using electric discharges {(generation and control
	of plasma in discharge tubes for surface treatment H01J 37/32, H01J 37/34)}
16/503	• • • using dc or ac discharges
16/505	using radio frequency discharges
16/507	••••• using external electrodes, e.g. in tunnel type
	reactors
16/509	using internal electrodes
16/5093	• • • • • {Coaxial electrodes}
16/5096	• • • • {Flat-bed apparatus}
16/511	• • • using microwave discharges
16/513	• • • using plasma jets
16/515	• • • using pulsed discharges
16/517	• • • using a combination of discharges covered by two or more of groups
	<u>C23C 16/503</u> - <u>C23C 16/515</u>
16/52	• Controlling or regulating the coating process
10,02	{(<u>C23C 16/45557, C23C 16/279</u> take
	precedence)}
16/54	Apparatus specially adapted for continuous
	coating
16/545	• • { for coating elongated substrates }
16/56	. After-treatment
18/00	Chemical coating by decomposition of either liquid
	compounds or solutions of the coating forming
	compounds, without leaving reaction products of surface material in the coating; Contact plating
	NOTE
	This groups covers also suspensions containing reactive liquids and non-reactive solid particles.
18/02	• by thermal decomposition
18/04	• Pretreatment of the material to be coated
	(<u>C23C 18/06</u> takes precedence)
18/06	• Coating on selected surface areas, e.g. using
	masks

18/08	• characterised by the deposition of metallic
	material
18/10	Deposition of aluminium only
18/12	characterised by the deposition of inorganic
	material other than metallic material
18/1204	• • {inorganic material, e.g. non-oxide and non-
	metallic such as sulfides, nitrides based
10/1000	compounds}
18/1208	• • • {Oxides, e.g. ceramics}
18/1212	{Zeolites, glasses}
18/1216	$\dots \qquad \{ \text{Metal oxides } (\underline{\text{C23C 18/1212}} \text{ takes} \}$
	precedence)}
18/122	• • • {Inorganic polymers, e.g. silanes,
10/1005	polysilazanes, polysiloxanes}
18/1225	{Deposition of multilayers of inorganic
10/1000	material}
18/1229	{Composition of the substrate}
18/1233	{Organic substrates}
18/1237	{Composite substrates, e.g. laminated,
10/10/11	premixed}
18/1241	{Metallic substrates}
18/1245	{Inorganic substrates other than metallic}
18/125	• • (Process of deposition of the inorganic
18/1254	<pre>material} {Sol or sol-gel processing}</pre>
18/1254	• • • {Spray pyrolysis}
18/1258	{involving particles, e.g. carbon nanotubes
16/1202	[CNT], flakes}
18/1266	• • • • {Particles formed <u>in situ</u> }
18/1200	{Preformed particles}
18/1275	 {performed under inert atmosphere}
18/1279	 {performed under mert atmosphere; {performed under reactive atmosphere, e.g.
10/12/9	oxidising or reducing atmospheres }
18/1283	• • • {Control of temperature, e.g. gradual
10/1203	temperature increase, modulation of
	temperature }
18/1287	• • • • {with flow inducing means, e.g. ultrasonic}
18/1291	• • • {by heating of the substrate}
18/1295	• • • • { with after-treatment of the deposited
	inorganic material}
18/14	• Decomposition by irradiation, e.g. photolysis,
	particle radiation {or by mixed irradiation sources}
18/143	• • {Radiation by light, e.g. photolysis or pyrolysis}
18/145	• • {Radiation by charged particles, e.g. electron
	beams or ion irradiation}
18/16	• by reduction or substitution, e.g. electroless plating
	(<u>C23C 18/54</u> takes precedence)
18/1601	• {Process or apparatus}
18/1603	• • {coating on selected surface areas}
18/1605	•••• {by masking}
18/1607	• • • {by direct patterning}
18/1608	{from pretreatment step, i.e. selective pre-
	treatment}
18/161	•••• {from plating step, e.g. inkjet}
18/1612	•••• {through irradiation means}
18/1614	• • • {plating on one side}
18/1616	•••• {interior or inner surface}
18/1617	• • • {Purification and regeneration of coating
	baths}
18/1619	• • {Apparatus for electroless plating}
18/1621	{Protection of inner surfaces of the
10/1/202	apparatus}
18/1623	• • • • • {through electrochemical processes}

18/1625	• • • • {through chemical processes}
18/1626	{through mechanical processes}
18/1628	{Specific elements or parts of the apparatus}
18/163	• • • • {Supporting devices for articles to be coated}
18/1632	• • • {Features specific for the apparatus, e.g. layout of cells and of its equipment, multiple cells}
18/1633	• • {Process of electroless plating}
18/1635	• • • {Composition of the substrate}
18/1637	• • • • {metallic substrate}
18/1639	••••• {Substrates other than metallic, e.g. inorganic or organic or non-conductive}
18/1641	• • • • • {Organic substrates, e.g. resin, plastic}
18/1642	{semiconductor (semiconductor H01L 21/288)}
18/1644	• • • • {porous substrates}
18/1646	• • • {Characteristics of the product obtained}
18/1648	• • • • {Porous product}
18/165	{Multilayered product (layered product <u>B32B</u>)}
18/1651	••••• {Two or more layers only obtained by electroless plating}
18/1653	••••• {Two or more layers with at least one layer obtained by electroless plating and one layer obtained by electroplating}
18/1655	{Process features}
18/1657	• • • • {Electroless forming, i.e. substrate
	removed or destroyed at the end of the
10/1470	process}
18/1658	• • • • { with two steps starting with metal deposition followed by addition of
10/100	reducing agent}
18/166	• • • • • { with two steps starting with addition of reducing agent followed by metal
10/16/2	deposition}
18/1662	•••• {Use of incorporated material in the solution or dispersion, e.g. particles, whiskers, wires}
18/1664	••••• {with additional means during the plating
	process}
18/1666	• • • • • {Ultrasonics}
18/1667	••••• {Radiant energy, e.g. laser}
18/1669	••••• {Agitation, e.g. air introduction}
18/1671	•••• {Electric field}
18/1673	{Magnetic field}
18/1675	· · · · {Process conditions}
18/1676	{Heating of the solution}
18/1678	{Heating of the substrate}
18/168	•••• {Control of temperature, e.g. temperature of bath, substrate}
18/1682	{Control of atmosphere}
18/1683	•••• {Control of electrolyte composition, e.g. measurement, adjustment (regeneration of
10/1/207	bath <u>C23C 18/1617</u>)}
18/1685	••••• {with supercritical condition, e.g. chemical fluid deposition}
18/1687	•••• {with ionic liquid}
18/1689	{After-treatment}
18/1691	•••• {Cooling, e g. forced or controlled cooling}
18/1692	{Heat-treatment}
18/1694	••••• {Sequential heat treatment}

18/1696	
	{Control of atmosphere}
18/1698	• • • • • {Control of temperature}
18/18	Pretreatment of the material to be coated
18/1803	 • {of metallic material surfaces or of a non- specific material surfaces}
18/1806	 • • {by mechanical pretreatment, e.g. grinding, sanding}
18/181	•••• {by formation of electrostatic charges, e.g. tribofriction}
18/1813	• • • • {by radiant energy}
18/1817	••••••••••••••••••••••••••••••••••••••
18/1817	••••• {Radiation, e.g. UV, laser}
18/1824	• • • • {Kadiation, e.g. 0 v, laser}
18/1827	{only one step pretreatment}
18/1831	••••• {Use of metal, e.g. activation, sensitisation with noble metals}
18/1834	••••• {Use of organic or inorganic compounds other than metals, e.g. activation, sensitisation with polymers}
18/1837	• • • • • {Multistep pretreatment}
18/1841	••••• {with use of metal first}
18/1844	••••••••••••••••••••••••••••••••••••••
18/1848	• • • • {by electrochemical pretreatment}
18/1848	• • • {of surfaces of non-metallic or semiconducting
	in organic material}
18/1855	• • • {by mechanical pretreatment, e.g. grinding, sanding}
	WARNING
	the groups <u>C23C 18/1855</u> - <u>C23C 18/1896</u> are not complete, pending reorganisation. See also <u>C23C 18/18</u>
18/1858	•••• {by formation of electrostatic charges, e.g. tribofriction}
18/1862	• • • {by radiant energy}
10/10/5	
18/1865	••••• {Heat}
18/1865	
18/1868	•••• {Radiation, e.g. UV, laser}
18/1868 18/1872	 {Radiation, e.g. UV, laser} {by chemical pretreatment}
18/1868	 {Radiation, e.g. UV, laser} {by chemical pretreatment} {only one step pretreatment} {Use of metal, e.g. activation,
18/1868 18/1872 18/1875 18/1879	 {Radiation, e.g. UV, laser} {by chemical pretreatment} {only one step pretreatment} {Use of metal, e.g. activation, sensitisation with noble metals}
18/1868 18/1872 18/1875	 {Radiation, e.g. UV, laser} {by chemical pretreatment} {only one step pretreatment} {Use of metal, e.g. activation, sensitisation with noble metals} {Use of organic or inorganic compounds
18/1868 18/1872 18/1875 18/1879	 {Radiation, e.g. UV, laser} {by chemical pretreatment} {only one step pretreatment} {Use of metal, e.g. activation, sensitisation with noble metals} {Use of organic or inorganic compounds other than metals, e.g. activation,
18/1868 18/1872 18/1875 18/1879 18/1882	 {Radiation, e.g. UV, laser} {by chemical pretreatment} {only one step pretreatment} {Use of metal, e.g. activation, sensitisation with noble metals} {Use of organic or inorganic compounds other than metals, e.g. activation, sensitisation with polymers}
18/1868 18/1872 18/1875 18/1879 18/1882 18/1886	 {Radiation, e.g. UV, laser} {by chemical pretreatment} {only one step pretreatment} {Use of metal, e.g. activation, sensitisation with noble metals} {Use of organic or inorganic compounds other than metals, e.g. activation, sensitisation with polymers} {Multistep pretreatment}
18/1868 18/1872 18/1875 18/1879 18/1882 18/1886 18/1889	 {Radiation, e.g. UV, laser} {by chemical pretreatment} {only one step pretreatment} {Use of metal, e.g. activation, sensitisation with noble metals} {Use of organic or inorganic compounds other than metals, e.g. activation, sensitisation with polymers} {Multistep pretreatment} {with use of metal first}
18/1868 18/1872 18/1875 18/1879 18/1882 18/1886	 {Radiation, e.g. UV, laser} {by chemical pretreatment} {only one step pretreatment} {Use of metal, e.g. activation, sensitisation with noble metals} {Use of organic or inorganic compounds other than metals, e.g. activation, sensitisation with polymers} {Multistep pretreatment} {with use of metal first} {with use of organic or inorganic
18/1868 18/1872 18/1875 18/1879 18/1882 18/1886 18/1889 18/1893	 {Radiation, e.g. UV, laser} {by chemical pretreatment} {only one step pretreatment} {Use of metal, e.g. activation, sensitisation with noble metals} {Use of organic or inorganic compounds other than metals, e.g. activation, sensitisation with polymers} {Multistep pretreatment} {with use of metal first} {with use of organic or inorganic compounds other than metals, first}
18/1868 18/1872 18/1875 18/1879 18/1882 18/1886 18/1889 18/1893 18/1896	 {Radiation, e.g. UV, laser} {by chemical pretreatment} {only one step pretreatment} {Use of metal, e.g. activation, sensitisation with noble metals} {Use of organic or inorganic compounds other than metals, e.g. activation, sensitisation with polymers} {Multistep pretreatment} {with use of metal first} {with use of organic or inorganic compounds other than metals, first} {with use of organic or inorganic compounds other than metals, first}
18/1868 18/1872 18/1875 18/1879 18/1882 18/1886 18/1889 18/1893 18/1896 18/20	 {Radiation, e.g. UV, laser} {by chemical pretreatment} {only one step pretreatment} {Use of metal, e.g. activation, sensitisation with noble metals} {Use of organic or inorganic compounds other than metals, e.g. activation, sensitisation with polymers} {Multistep pretreatment} {with use of metal first} {with use of organic or inorganic compounds other than metals, first} {with use of organic or inorganic compounds other than metals, first}
18/1868 18/1872 18/1875 18/1879 18/1882 18/1886 18/1889 18/1893 18/1893 18/1896 18/20 18/2006	 {Radiation, e.g. UV, laser} {by chemical pretreatment} {only one step pretreatment} {Use of metal, e.g. activation, sensitisation with noble metals} {Use of organic or inorganic compounds other than metals, e.g. activation, sensitisation with polymers} {Multistep pretreatment} {with use of metal first} {with use of organic or inorganic compounds other than metals, first} {with use of organic or inorganic compounds other than metals, first} {with use of pretreatment} {by electrochemical pretreatment} {by other methods than those of C23C 18/22 - C23C 18/30}
18/1868 18/1872 18/1875 18/1879 18/1882 18/1886 18/1889 18/1893 18/1896 18/20	 {Radiation, e.g. UV, laser} {by chemical pretreatment} {only one step pretreatment} {Use of metal, e.g. activation, sensitisation with noble metals} {Use of organic or inorganic compounds other than metals, e.g. activation, sensitisation with polymers} {Multistep pretreatment} {with use of metal first} {with use of organic or inorganic compounds other than metals, first} {with use of organic or inorganic compounds other than metals first} {with use of organic or inorganic compounds other than metals, first} {by electrochemical pretreatment} {by other methods than those of
18/1868 18/1872 18/1875 18/1879 18/1882 18/1886 18/1889 18/1893 18/1893 18/1896 18/20 18/2006	 {Radiation, e.g. UV, laser} {by chemical pretreatment} {only one step pretreatment} {Use of metal, e.g. activation, sensitisation with noble metals} {Use of organic or inorganic compounds other than metals, e.g. activation, sensitisation with polymers} {Multistep pretreatment} {with use of metal first} {with use of organic or inorganic compounds other than metals, first} {with use of metal first} {by electrochemical pretreatment} {by other methods than those of C23C 18/22 - C23C 18/30} {by mechanical pretreatment, e.g.
18/1868 18/1872 18/1875 18/1879 18/1882 18/1886 18/1889 18/1893 18/1893 18/1896 18/20 18/2006	 {Radiation, e.g. UV, laser} {by chemical pretreatment} {only one step pretreatment} {Use of metal, e.g. activation, sensitisation with noble metals} {Use of organic or inorganic compounds other than metals, e.g. activation, sensitisation with polymers} {Multistep pretreatment} {with use of metal first} {with use of organic or inorganic compounds other than metals, first} {with use of organic or inorganic compounds other than metals, first} {with use of organic or inorganic compounds other than metals, first} {by electrochemical pretreatment} {by other methods than those of C23C 18/22 - C23C 18/30} {by mechanical pretreatment, e.g. grinding, sanding} WARNING
18/1868 18/1872 18/1875 18/1879 18/1882 18/1886 18/1889 18/1893 18/1893 18/1896 18/20 18/2006	 {Radiation, e.g. UV, laser} {by chemical pretreatment} {only one step pretreatment} {Use of metal, e.g. activation, sensitisation with noble metals} {Use of organic or inorganic compounds other than metals, e.g. activation, sensitisation with polymers} {Multistep pretreatment} {with use of metal first} {with use of organic or inorganic compounds other than metals, first} {with use of organic or inorganic compounds other than metals, first} {with use of organic or inorganic compounds other than metals, first} {by electrochemical pretreatment} {by other methods than those of C23C 18/22 - C23C 18/30} {by mechanical pretreatment, e.g. grinding, sanding}
18/1868 18/1872 18/1875 18/1879 18/1882 18/1886 18/1889 18/1893 18/1896 18/200 18/2006 18/2013	 {Radiation, e.g. UV, laser} {by chemical pretreatment} {only one step pretreatment} {Use of metal, e.g. activation, sensitisation with noble metals} {Use of organic or inorganic compounds other than metals, e.g. activation, sensitisation with polymers} {Multistep pretreatment} {with use of metal first} {with use of organic or inorganic compounds other than metals, first} {with use of metal first} {with use of organic or inorganic compounds other than metals, first} {with use of organic or inorganic compounds other than metals, first} {by electrochemical pretreatment} {by electrochemical pretreatment} {by other methods than those of C23C 18/22 - C23C 18/30} {by mechanical pretreatment, e.g. grinding, sanding} WARNING the groups C23C 18/2013 - C23C 18/2093 are not complete, pending reorganisation. See also C23C 18/2006
18/1868 18/1872 18/1875 18/1879 18/1882 18/1886 18/1889 18/1893 18/1893 18/1896 18/20 18/2006	 {Radiation, e.g. UV, laser} {by chemical pretreatment} {only one step pretreatment} {Use of metal, e.g. activation, sensitisation with noble metals} {Use of organic or inorganic compounds other than metals, e.g. activation, sensitisation with polymers} {Multistep pretreatment} {with use of metal first} {with use of organic or inorganic compounds other than metals, first} {with use of organic or inorganic compounds other than metals, first} {with use of organic or inorganic compounds other than metals, first} {by electrochemical pretreatment} {by electrochemical pretreatment} {by other methods than those of C23C 18/22 - C23C 18/30}

С	23	С

18/2026 18/2033	••••• {by radiant energy}	<u>Chen</u> the su
18/2033	$\cdot \cdot \cdot \cdot \cdot \cdot \cdot \{\text{Radiation, e.g. UV, laser}\}$	
18/2046	••••••••••••••••••••••••••••••••••••••	22
18/2053	• • • • • {only one step pretreatment}	
18/206	••••••••••••••••••••••••••••••••••••••	
	and tin, e.g. activation, sensitisation with metals (sensitising with tin <u>C23C 18/285</u> , sensitising with noble metals <u>C23C 18/30</u>)}	
18/2066	••••• {Use of organic or inorganic compounds other than metals, e.g. activation, sensitisation with polymers}	
18/2073	••••• {Multistep pretreatment}	
18/208	••••• {with use of metal first}	
18/2086	••••• {with use of organic or inorganic	
10/2002	compounds other than metals, first}	22
18/2093	•••• {by electrochemical pretreatment}	22
18/22	• • • Roughening, e.g. by etching	22
18/24 18/26	using acid aqueous solutions	22
18/28		22
18/285	Sensitising or activating Sensitising or activating with tin based	
10/205	compound or composition}	22
18/30	• • • • • • • • • • • • • • • • • • •	22
	with palladium or other noble metal }	22
18/31	Coating with metals	22
18/32	Coating with nickel, cobalt or mixtures thereof	22
	with phosphorus or boron ($C23C 18/50$ takes precedence)	22 22
18/34	using reducing agents	22
18/36	• • • • using hypophosphites	22 22
18/38	• • • Coating with copper	22
18/40	• • • using reducing agents	22
18/405 18/42	• • • • {Formaldehyde}	22
18/42	 Coating with noble metals using reducing agents 	22
18/44	Coating with alloys	22
18/50	 . Coating with alloys . with alloys based on iron, cobalt or nickel 	22
18/52	 using reducing agents for coating with metallic 	22
10/32	material not provided for in a single one of groups	22
	<u>C23C 18/32 - C23C 18/50</u>	22
18/54	• Contact plating, i.e. electroless electrochemical	22
	plating	22
20/00	Chemical coating by decomposition of either solid	22
_ 0,00	compounds or suspensions of the coating forming	22
	compounds, without leaving reaction products of	22
	surface material in the coating	22
	NOTE	22
	This group <u>covers</u> also suspensions containing non-reactive liquids and reactive solid particles.	22 22
20/02	• Coating with metallic material	22
20/02	• • with metals	
20/04	Coating with inorganic material, other than metallic	22
	material	22
20/08	• • with compounds, mixtures or solid solutions, e.g. borides, carbides, nitrides	22
		22
		22
		22

<u>Chemical surface treatment of metallic material by reaction of</u> <u>the surface with a reactive medium</u>

22/00	Chemical surface treatment of metallic material by reaction of the surface with a reactive liquid, leaving reaction products of surface material in the coating, e.g. conversion coatings, passivation of metals		
	<u>NOTES</u>		
	 This group <u>covers</u> also suspensions containing reactive liquids and non-reactive solid particles. In groups <u>C23C 22/02</u> - <u>C23C 22/86</u>, in the absence of an indication to the contrary, classification is made in the last appropriate place. Rejuvenating of the bath is classified in the appropriate place for the specific bath composition. 		
22/02	• using non-aqueous solutions		
22/03	containing phosphorus compounds		
22/04	• • containing hexavalent chromium compounds		
22/05	• using aqueous solutions		
22/06	using aqueous acidic solutions with pH less than		
	6		
22/07	containing phosphates		
22/08	Orthophosphates		
22/10	containing oxidants		
22/12 22/13	containing zinc cations		
22/13	 containing also nitrate or nitrite anions containing also chlorate anions 		
22/14	containing also peroxy-compounds		
22/10	containing also organic acids		
22/17	containing manganese cations		
22/182	{containing also zinc cations}		
22/182	••••••••••••••••••••••••••••••••••••••		
22/186	••••• {containing also copper cations}		
22/188	{containing also magnesium cations}		
22/20	containing aluminium cations		
22/22	••••• containing alkaline earth metal cations		
22/23	Condensed phosphates		
22/24	containing hexavalent chromium compounds		
22/26	containing also organic compounds		
22/27	Acids		
22/28	Macromolecular compounds		
22/30	containing also trivalent chromium		
22/32	• • • • containing also pulverulent metals		
22/33	containing also phosphates		
22/34	containing fluorides or complex fluorides		
22/36	containing also phosphates		
22/361	••••• {containing titanium, zirconium or		
	hafnium compounds}		
22/362	{containing also zinc cations}		
22/364	{containing also manganese cations}		
22/365	{containing also zinc and nickel cations}		
22/367	•••• {containing alkaline earth metal cations}		
22/368	•••• {containing magnesium cations}		
22/37	containing also hexavalent chromium compounds		
22/38	containing also phosphates		
22/40	containing molybdates, tungstates or vanadates		
22/42	• • • containing also phosphates		

22/43	containing also hexavalent chromium compounds	24/103	• • • {Coating with metallic material, i.e. metals or metal alloys, optionally comprising hard
22/44	containing also fluorides or complex fluorides	24/106	particles, e.g. oxides, carbides or nitrides} {Coating with metal alloys or metal elements
22/46	containing oxalates	2-1/100	only}
22/40	containing oxalates		omy
		26/00	Coating not provided for in groups
22/48	not containing phosphates, hexavalent chromium compounds, fluorides or complex		<u>C23C 2/00</u> - <u>C23C 24/00</u>
	fluorides, molybdates, tungstates, vanadates or	26/02	• applying molten material to the substrate
	oxalates	28/00	Coating for obtaining at least two superposed
22/50	Treatment of iron or alloys based thereon		coatings either by methods not provided for in
22/52	Treatment of copper or alloys based thereon		a single one of groups <u>C23C 2/00</u> - <u>C23C 26/00</u>
22/53	Treatment of zinc or alloys based thereon		or by combinations of methods provided for in
22/54	Treatment of refractory metals or alloys based thereon	28/02	subclasses <u>C23C</u> and <u>C25C</u> or <u>C25D</u> only coatings {only including layers} of metallic
22/56	Treatment of aluminium or alloys based		material
	thereon	28/021	• • {including at least one metal alloy layer}
22/57	Treatment of magnesium or alloys based	28/022	• • • {with at least one MCrAlX layer}
	thereon	28/023	• • {only coatings of metal elements only}
22/58	Treatment of other metallic material	28/025	• • { with at least one zinc-based layer }
22/60	• • using alkaline aqueous solutions with pH greater	28/026	• {including at least one amorphous metallic
22/00	than 8		material layer}
22/62	• • • Treatment of iron or alloys based thereon	28/027	• • {including at least one metal matrix material
22/63	Treatment of non of alloys based thereon Treatment of copper or alloys based thereon	20,021	comprising a mixture of at least two metals or
22/63	Treatment of refractory metals or alloys based		metal phases or metal matrix composites, e.g.
	thereon		metal matrix with embedded inorganic hard particles, CERMET, MMC.}
22/66	• • • Treatment of aluminium or alloys based	28/028	• • {Including graded layers in composition or in
00/67	thereon	20,020	physical properties, e.g. density, porosity, grain
22/67	• • • • with solutions containing hexavalent		size}
22/60	chromium	28/04	• only coatings of inorganic non-metallic material
22/68	• • using aqueous solutions with pH between 6 and 8	28/042	 (including a refractory ceramic layer, e.g.)
22/70	• using melts	20/042	refractory metal oxides, ZrO ₂ , rare earth oxides}
22/72	. Treatment of iron or alloys based thereon	28/044	• {coatings specially adapted for cutting tools or
22/73	 characterised by the process 	20/044	wear applications}
22/74	• • for obtaining burned-in conversion coatings	28/046	• { with at least one amorphous inorganic material
22/76	• • Applying the liquid by spraying	28/040	layer, e.g. DLC, a-C:H, a-C:Me, the layer being
22/77	• • Controlling or regulating of the coating process		doped or not}
22/78	. Pretreatment of the material to be coated	28/048	• {with layers graded in composition or physical
22/80	with solutions containing titanium or zirconium	20/040	properties}
	compounds	28/30	• {Coatings combining at least one metallic layer and
22/82	. After-treatment		at least one inorganic non-metallic layer}
22/83	Chemical after-treatment	28/32	• • {including at least one pure metallic layer}
22/84	Dyeing	28/321	• • { with at least one metal alloy layer }
22/86	Regeneration of coating baths	28/3215	• • • {at least one MCrAIX layer}
A 1/0.0		28/322	• • {only coatings of metal elements only}
24/00	Coating starting from inorganic powder (spraying	28/3225	• • • {with at least one zinc-based layer}
	of the coating material in molten state $\underline{C23C4/00}$;		· · · ·
04/02	solid state diffusion <u>C23C 8/00</u> - <u>C23C 12/00</u>)	28/323	• • • {with at least one amorphous metallic material layer}
24/02	• by application of pressure only	28/324	• • { with at least one metal matrix material layer
24/04	Impact or kinetic deposition of particles	20/324	comprising a mixture of at least two metals or
24/045	• • • {by trembling using impacting inert media}		metal phases or a metal-matrix material with
24/06	Compressing powdered coating material, e.g. by milling		hard embedded particles, e.g. WC-Me}
24/08	• by application of heat or pressure and heat (<u>C23C 24/04</u> takes precedence)	28/325	• • { with layers graded in composition or in physical properties }
24/082	 {without intermediate formation of a liquid in the layer} 	28/34	• • {including at least one inorganic non-metallic material layer, e.g. metal carbide, nitride, boride,
24/085	• • {Coating with metallic material, i.e. metals		silicide layer and their mixtures, enamels,
24/000	or metal alloys, optionally comprising hard		phosphates and sulphates}
	particles, e.g. oxides, carbides or nitrides}	28/341	• • { with at least one carbide layer }
21/007		28/343	• • • { with at least one DLC or an amorphous carbon
24/087	• • • {Coating with metal alloys or metal elements only}		based layer, the layer being doped or not}
24/10	• • with intermediate formation of a liquid phase in	28/345	• • • {with at least one oxide layer}
24/10	the layer		· · ·
	are myer		

28/3455	•••• { with a refractory ceramic layer, e.g. refractory metal oxide, ZrO ₂ , rare earth oxides or a thermal barrier system comprising at least one refractory oxide layer }
28/347	• • { with layers adapted for cutting tools or wear applications }
28/36	 {including layers graded in composition or physical properties}
28/40	• {Coatings including alternating layers following a pattern, a periodic or defined repetition}
28/42	 {characterized by the composition of the alternating layers}
28/44	• {characterized by a measurable physical property of the alternating layer or system, e.g. thickness, density, hardness}
30/00	Coating with metallic material characterised only by the composition of the metallic material, i.e. not characterised by the coating process (<u>C23C 26/00</u> , <u>C23C 28/00</u> take precedence)
30/005	• {on hard metal substrates}

2222/00	Aspects relating to chemical surface treatment of metallic material by reaction of the surface with a reactive medium
2222/10	• Use of solutions containing trivalent chromium but
	free of hexavalent chromium
2222/20	• Use of solutions containing silanes